

IN THE UNITED STATES PATENT AND TRADEMARK OFFICE

In re application of: Cheng et al.

Attorney Docket No.: LSI1P184/03-69300

Application No.: 09/996,118

Examiner: Rao, S.

Filed: 11/27/2001

Group: 2814

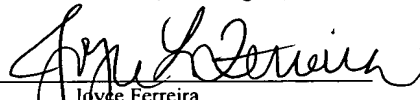
Title: Low Resistance Metal Interconnect Lines
and a Process for Fabricating Them

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I hereby certify that this correspondence is being deposited with the United States Postal Service as First Class Mail in an envelope addressed to: Commissioner for Patents, Washington, DC 20231 on December 27, 2002

Signed: _____


Joyce Ferreira

Amendment C

Commissioner for Patents
Washington, D.C. 20231

Dear Sir:

This amendment and the enclosed remarks are submitted with a request for continued examination of the application. Applicants had previously submitted an amendment and response to the Office Action mailed on August 27, 2002. In an Advisory Action mailed in 11-15-02, the Examiner indicated that the proposed amendments would be entered but rejected the claims upon the same grounds raised by the examiner in the August 27, 2002 office action. Applicants have further amended the claims which are now submitted with the request for continued examination. Applicants respectfully submit that the attached amendments and remarks fully address the issues raised in the Office Action and respectfully request a complete reconsideration of the captioned application in view of the following remarks and amendments.

In the Claims:

Please amend the claims as follows:

Please cancel claims 6 and 9-11 without prejudice.

Please enter the following new claims: